

FCP16N60N / FCPF16N60NT N-Channel SupreMOS[®] MOSFET **600 V, 16 A, 199 m**Ω

Features

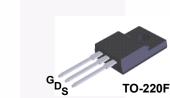
- $R_{DS(on)}$ = 170 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 8 A
- Ultra Low Gate Charge (Typ. Q_q = 40.2 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 176 pF)
- 100% Avalanche Tested
- · RoHS Compliant

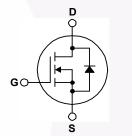
Application

- LCD/LED/PDP TV
- Lighting
- · Solar Inverter
- · AC-DC Power Supply

Description

The SupreMOS[®] MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

TO-220

	Parameter			FCPF16N60NT	Unit	
Drain to Source Voltage			6	V		
Gate to Source Voltage			±	:30	V	
Desire Coment	- Continuous (T _C = 25 ^o C)	- Continuous (T _C = 25°C)		16.0*	٨	
Drain Current	- Continuous (T _C = 100 ^o C)		10.1	10.1*	A	
Drain Current	- Pulsed	(Note 1)	48.0	48.0*	Α	
Single Pulsed Avalanche	(Note 2)	3	mJ			
Avalanche Current		(Note 1)	5.3		Α	
Repetitive Avalanche Energy		(Note 1)	1.34		mJ	
MOSFET dv/dt			100		V/ns	
Peak Diode Recovery dv/dt		(Note 3)	20		V/ns	
Devuer Dissingtion	$(T_{C} = 25^{\circ}C)$	$(T_{\rm C} = 25^{\rm o}{\rm C})$		35.7	W	
Power Dissipation	- Derate Above 25°C		1.08	0.29	W/ºC	
Operating and Storage Temperature Range			-55 to	°C		
 Operating and Storage Temperature Range Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds 			300		°C	
	Gate to Source Voltage Drain Current Drain Current Single Pulsed Avalanche Avalanche Current Repetitive Avalanche En MOSFET dv/dt Peak Diode Recovery dv Power Dissipation Operating and Storage T	$\begin{array}{c} \mbox{Drain to Source Voltage} \\ \mbox{Gate to Source Voltage} \\ \mbox{Gate to Source Voltage} \\ \mbox{Drain Current} & - Continuous (T_C = 25^{\circ}C) \\ - Continuous (T_C = 100^{\circ}C) \\ \mbox{Drain Current} & - Pulsed \\ \mbox{Single Pulsed Avalanche Energy} \\ \mbox{Avalanche Current} \\ \mbox{Repetitive Avalanche Energy} \\ \mbox{MOSFET dv/dt} \\ \mbox{Peak Diode Recovery dv/dt} \\ \mbox{Power Dissipation} & \frac{(T_C = 25^{\circ}C) \\ - Derate Above 25^{\circ}C \\ \mbox{Operating and Storage Temperature Range} \\ \end{array}$	$\begin{array}{c} \mbox{Drain to Source Voltage} \\ \mbox{Gate to Source Voltage} \\ \mbox{Gate to Source Voltage} \\ \mbox{Drain Current} & - \mbox{Continuous} (T_C = 25^{\circ}C) \\ \mbox{- Continuous} (T_C = 100^{\circ}C) \\ \mbox{- Note 1} \\ \mbox{Note 2} \\ \mbox{Avalanche Current} & (Note 1) \\ \mbox{Repetitive Avalanche Energy} & (Note 1) \\ \mbox{Repetitive Avalanche Energy} & (Note 1) \\ \mbox{Repetitive Avalanche Energy} & (Note 1) \\ \mbox{MOSFET dv/dt} \\ \mbox{Peak Diode Recovery dv/dt} & (Note 3) \\ \mbox{Power Dissipation} & \frac{(T_C = 25^{\circ}C) \\ \mbox{- Derate Above 25^{\circ}C} \\ \mbox{Operating and Storage Temperature Range} \\ \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

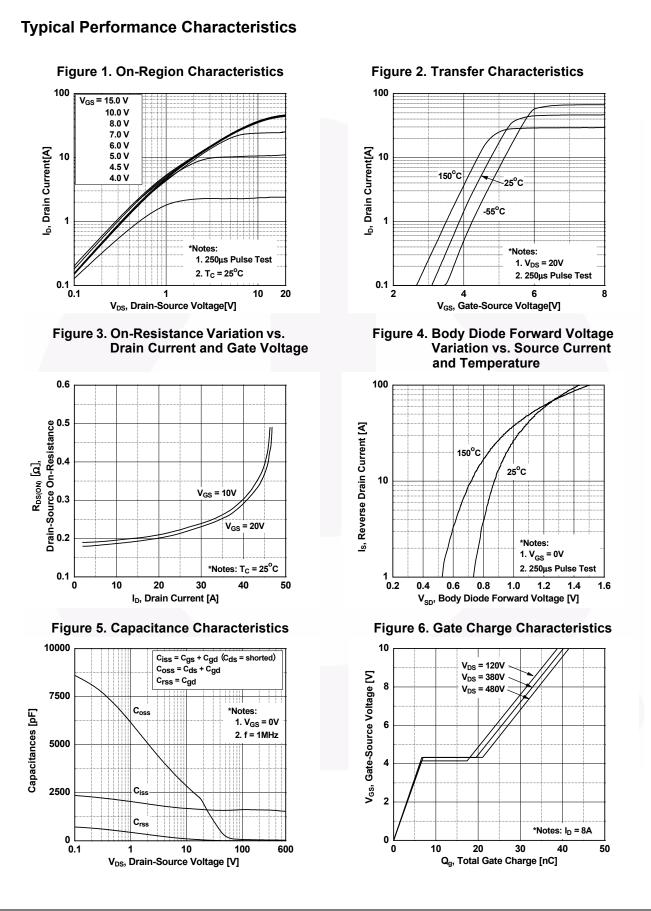
Drain current limited by maximum junction temperature.

Thermal Characteristics

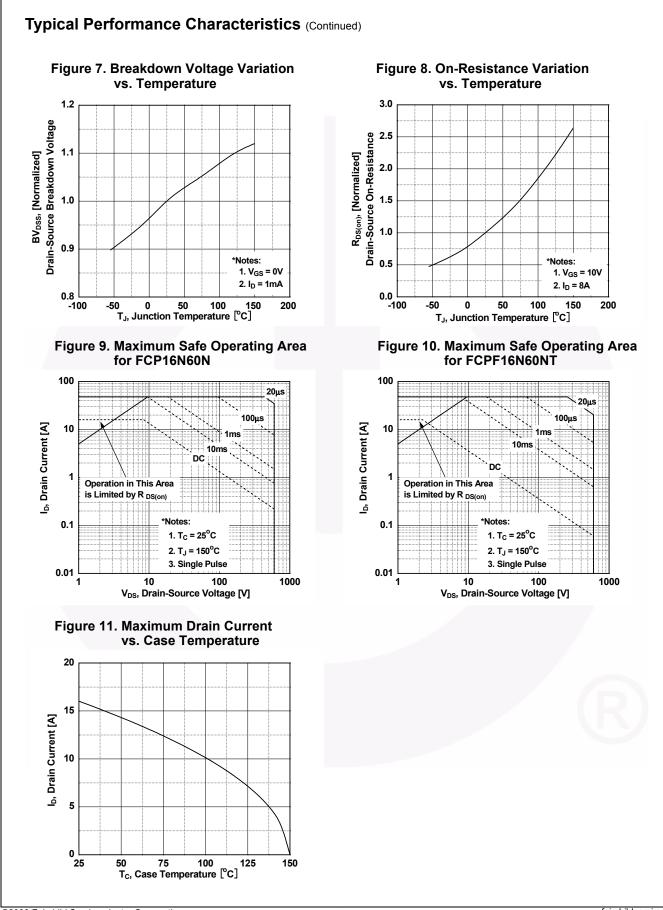
Symbol	Parameter	FCP16N60N	FCPF16N60NT	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.93	3.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	0/11

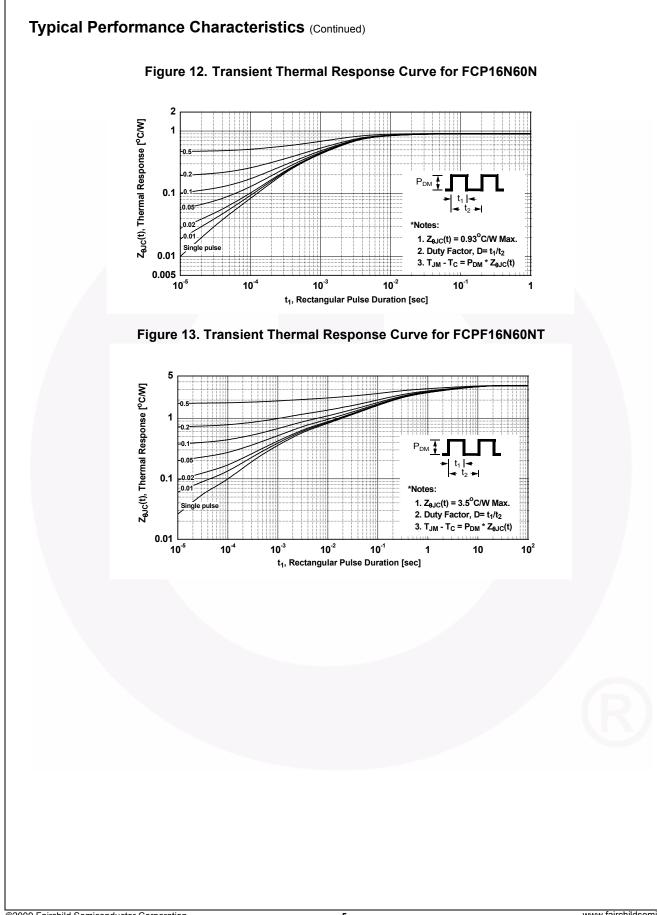
November 2013

Part Nur	nber	Top Mark	Pack	age	Packing Method	Reel Size	Та	pe Width	Qua	ntity	
FCP16N	160N	FCP16N60N	TO-2	220	Tube	N/A		N/A	50	50 units	
FCPF16N	160NT	FCPF16N60NT	TO-2	20F	Tube	N/A		N/A	50 units		
Electrica	l Chara	acteristics T _C = 2	5ºC unle	ss othe	erwise noted.						
Symbol		Parameter	-		Test Condition	ns	Min.	Тур.	Max.	Uni	
Off Charac	teristics	6									
BV _{DSS}	Drain to	Source Breakdown Vol	tage	In	= 1 mA, V _{GS} = 0V, T _C	= 25°C	600	-	-	V	
ΔBV _{DSS} / ΔT _{.l}		wn Voltage Temperatur	-	$I_D = 1$ mA, Referenced to 25°C			-	0.73	-	V/ºC	
				V	_{DS} = 480 V, V _{GS} = 0 V		-	-	10		
DSS	SS Zero Gate Voltage Drain Current		it	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			-	-	100	μA	
I _{GSS}	Gate to I	Body Leakage Current			$_{\rm SS} = \pm 30 \text{ V}, \text{ V}_{\rm DS} = 0 \text{ V}$		-	-	±100	nA	
On Charac	teristics	5									
V _{GS(th)}		reshold Voltage	-	V	_{GS} = V _{DS} , I _D = 250 μA		2.0	-	4.0	V	
R _{DS(on)}		ain to Source On Resis	tance		$_{3S} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		-	0.170	0.199	Ω	
9FS		Transconductance		$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 8 \text{ A}$			-	13	-	S	
										1	
C _{iss}	Input Capacitance					<u> </u>	1630	2170	pF		
		Capacitance	-	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		_		70	95	pF	
C _{oss}	-	Transfer Capacitance	_				5	10	pF		
C _{rss}		out Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz				40	60	pF	
C _{oss}	-	Effective Output Capacitance		$V_{DS} = 0.00 \text{ V}, V_{GS} = 0.00 \text{ V}, 1 = 1.0012$ $V_{DS} = 0.00 \text{ to } 480 \text{ V}, V_{GS} = 0.00 \text{ V}$			-	176		pF	
C _{oss(eff.)} Q _{g(tot)}		Total Gate Charge at 10V				-	40.2	52.3	nC		
Q_{gs}		Source Gate Charge			$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 8 \text{ A},$		-	6.7	-	nC	
∝ _{gs} Q _{gd}		Drain "Miller" Charge		V _{GS} = 10 V (Note 4)		-	12.9	-	nC		
esr	Equivalent Series Resistance (G-S)		3-S)	f = 1 MHz				2.9		Ω	
Switching	· ·	,	/				_				
•								15.8	41.6	ns	
t _{d(on)} t _r	Turn-On Delay Time Turn-On Rise Time			Vr	V _{DD} = 380 V, I _D = 8 A,			15.5	41.0	ns	
r t _{d(off)}		Delay Time			$_{\rm GS}$ = 10 V, R _G = 4.7 Ω	_	-	60.3	130.6	ns	
t _f		Fall Time			(Note 4)		-	20.2	50.4	ns	
						(_0			
		e Characteristics		odo Er				_	16	A	
l _S Isu	Maximum Continuous Drain to Source							48	A		
I _{SM} V _{SD}	Maximum Pulsed Drain to Source Diod Drain to Source Diode Forward Voltage			$V_{GS} = 0 V, I_{SD} = 8 A$				-	1.2	V	
t _{rr}		Recovery Time	voltage				-	319	-	ns	
Q _{rr}		Recovery Charge			V _{GS} = 0 V, I _{SD} = 8 A, dI _F /dt = 100 A/μs		-	4.4	_	μΟ	
		ricectery enalge			•					μο	
. I _{AS} = 5.3 A, R _G	= 25 Ω, starting ≤ 200 A/μs, V _I	imited by maximum junction ter g T _J = 25°C. _{DD} = 380 V, starting T _J = 25°C erating temperature typical char									

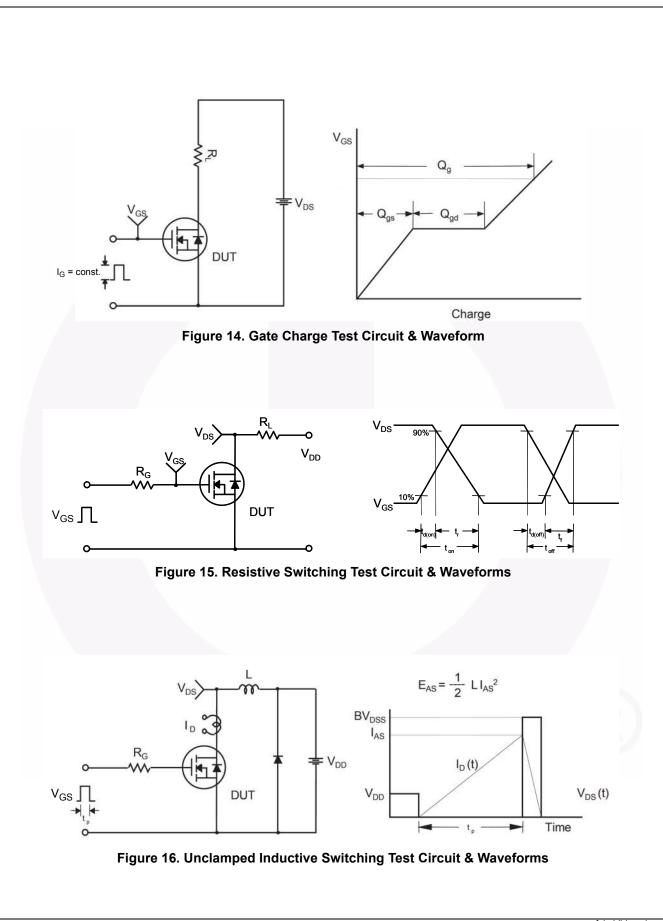


www.fairchildsemi.com

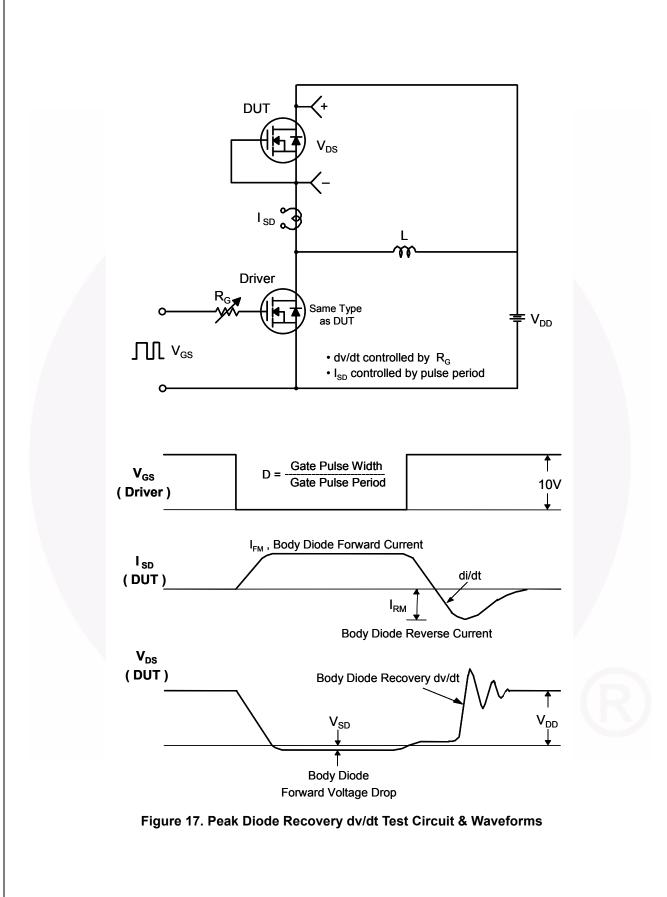




5



FCP16N60N / FCPF16N60NT — N-Channel SupreMOS[®] MOSFET



FCP16N60N / FCPF16N60NT — N-Channel SupreMOS® MOSFET

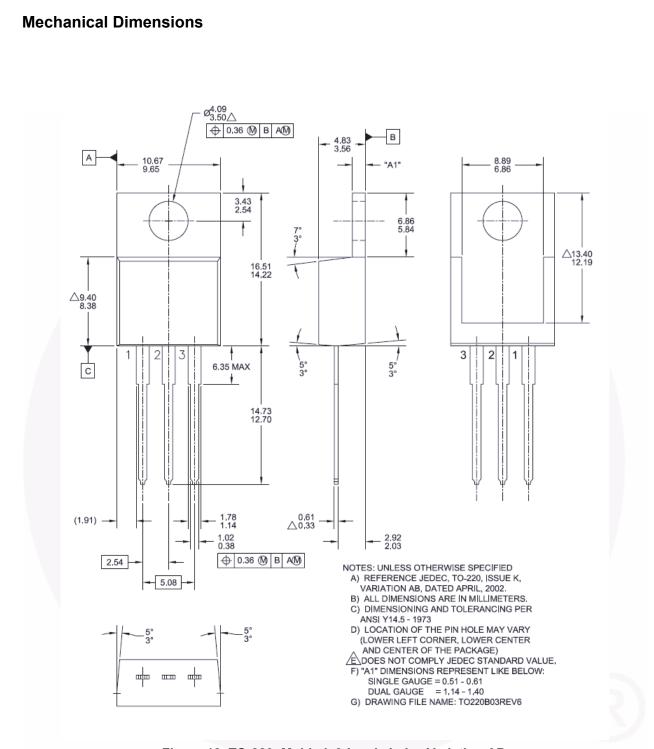
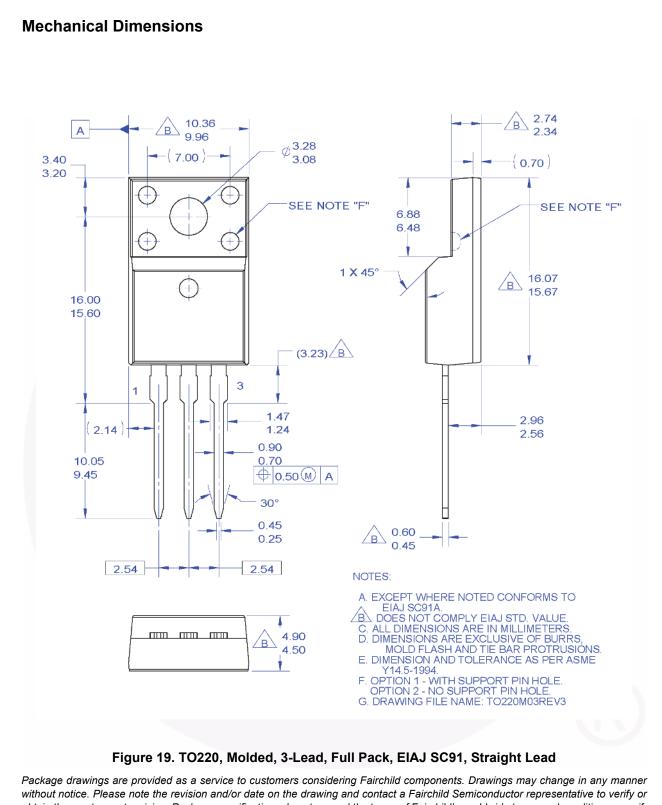


Figure 18. TO-220, Molded, 3-Lead, Jedec Variation AB

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT220-003



obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF220-003

FCP16N60N / FCPF16N60NT — N-Channel SupreMOS[®] MOSFET



SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ AX-CAP®* BitSiC™ Build it Now™ CorePLUS™ CorePOWER™ <i>CROSSVOLT</i> ™ CTL™ CUrrent Transfer Logic™ DEUXPEED® DUAI Cool™ EcoSPARK®	
EfficentMax™ ESBC™	
R	

Fairchild® Fairchild Semiconductor® FACT Quiet Series™ FACT[®] FAST[®] FastvCore™ FETBench™ FPS™

F-PFS™ FRFET® Global Power ResourceSM GreenBridge™ Green FPS™ Green FPS™ e-Series™ G*max*™ GTO™ IntelliMAX™ ISOPLANAR™ Marking Small Speakers Sound Louder and Better™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver® OptoHiT™ **OPTOLOGIC® OPTOPLANAR[®]**

PowerTrench® PowerXS™ Programmable Active Droop™ QFET QS™ Quiet Series™ RapidConfigure[™] Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ Solutions for Your Success™ SPM® STEALTH™ SuperFET[®] SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS®

Sync-Lock™ SYSTEM^{®*} GENERAL TinyBoost[®] TinyBuck® TinyCalc™ TinyLogic® TINYOPTO™ TinvPower™ TinyPWM™ TinyWire™ TranSiC™ TriFault Detect™ TRUECURRENT®* µSerDes™ $\mu_{\scriptscriptstyle{\mathrm{Serie}}}$ UHC® Ultra FRFET™ UniFFT™ VCX™ VisualMax™

VoltagePlus™

XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

SvncFET™

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Tern

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.